PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CEO</sub>	-50V
I <sub>C</sub>	-100mA
R <sub>1</sub>	10kΩ

### Features

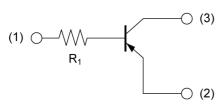
- 1) Built-In Biasing Resistor
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC114T series

## Application

INVERTER, INTERFACE, DRIVER

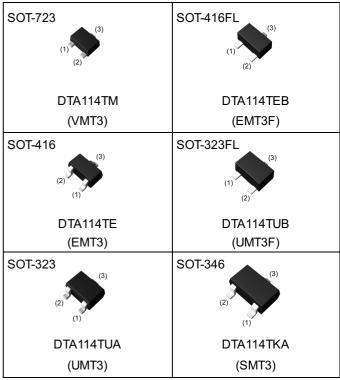
### Inner circuit

DTA114TM/ DTA114TEB/ DTA114TUB

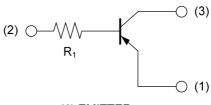


- (1) BASE
- (2) EMITTER
- (3) COLLECTOR

### Outline



### DTA114TE/ DTA114TUA/ DTA114TKA



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA114TM	SOT-723	1212	T2L	180	8	8000	94
DTA114TEB	SOT-416FL	1616	TL	180	8	3000	94
DTA114TE	SOT-416	1616	TL	180	8	3000	94
DTA114TUB	SOT-323FL	2021	TL	180	8	3000	94
DTA114TUA	SOT-323	2021	T106	180	8	3000	94
DTA114TKA	SOT-346	2928	T146	180	8	3000	94

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Pa	arameter	Symbol	Values	Unit
Collector-base voltage			-50	V
Collector-emitter voltage	Collector-emitter voltage			V
Emitter-base voltage		V <sub>EBO</sub>	-5	V
Collector current			-100	mA
	DTA114TM		150	mW
	DTA114TEB		150	
Dayyar dissination	DTA114TE	P <sub>D</sub> *1	150	
Power dissipation	DTA114TUB	P <sub>D</sub> .	200	
	DTA114TUA		200	
	DTA114TKA		200	
Junction temperature			150	°C
Range of storage temperat	ure	T <sub>stg</sub>	-55 to +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Damanatan	Symbol Conditions		Values			1.1
Parameter			Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -50μA	-50	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-50	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -50μA	-5	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V	-	-	-500	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -4V	-	-	-500	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -10mA, I <sub>B</sub> = -1mA	-	-	-300	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = -5V, I_{C} = -1mA$	100	250	600	-
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ
Transition frequency	f <sub>T</sub> *2	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Each terminal mounted on a reference land.

<sup>\*2</sup> Characteristics of built-in transistor

## ● Electrical characteristic curves(Ta=25°C)

Fig.1 Grounded emitter propagation characteristics

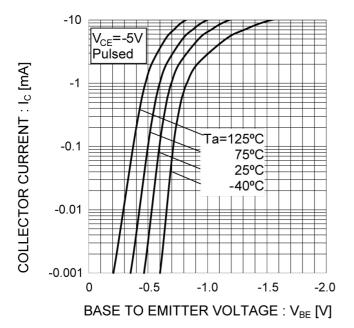
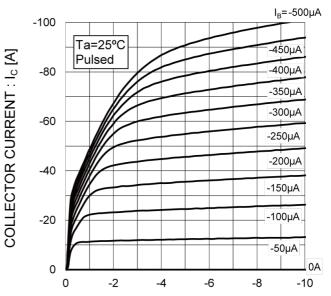


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector
Current

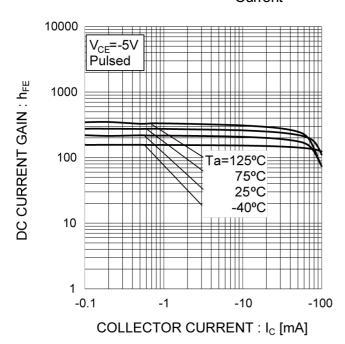
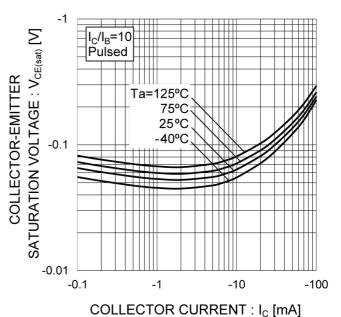
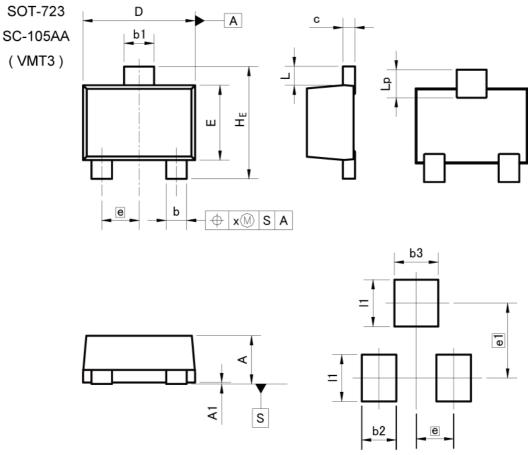


Fig.4 Collector-Emitter Saturation
Voltage vs. Collector Current





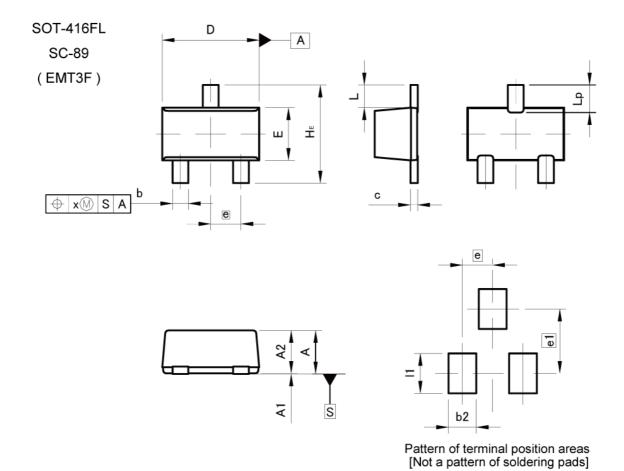
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
b1	0.27	0.37	0.011	0.015	
С	0.08	0.18	0.003	0.007	
D	1.10	1.30	0.043	0.051	
E	0.70	0.90	0.028	0.035	
е	0.	0.40		.02	
HE	1.10	1.30	0.043	0.051	
L	0.10	0.30	0.004	0.012	
Lp	0.20	0.40	0.008	0.016	
х	-	0.10	_	0.004	

DIM	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50		0.020

Dimension in mm/inches



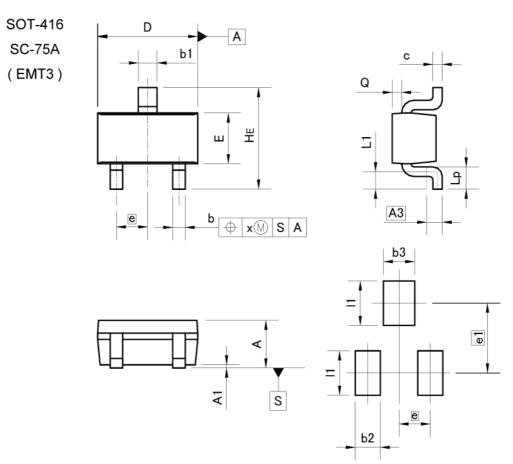


3.797.777.2577	MILIM	METERS INCHES		MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX		
	INITIA	WAA	INITIA	IVIAA		
Α	0.65	0.85	0.026	0.033		
A1	0.00	0.10	0.000	0.004		
A2	0.60	0.80	0.024	0.031		
b	0.21	0.36	0.008	0.014		
С	0.08	0.18	0.003	0.007		
D	1.50	1.70	0.059	0.067		
E	0.76	0.96	0.030	0.038		
е	0.	50	0.020			
HE	1.50	1.70	0.059	0.067		
L	0.37		0.0	15		
Lp	0.35	0.55	0.014	0.022		
×	-	0.10	-	0.004		

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	_	0.46	_	0.018
e1	_	1.05	-	0.041
- 11	-	0.65	-	0.026

Dimension in mm/inches





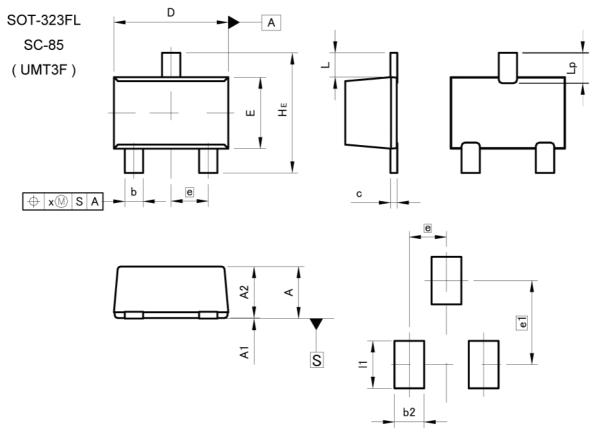
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15		0.006	% <del>-</del>
Q	0.05	0.25	0.002	0.010
х	\ <del>-</del>	0.10	, <del>-</del> ,	0.004

DIM	MILIM	ETERS	INCHES	
DIW	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	43
l1		0.70		0.028

Dimension in mm/inches





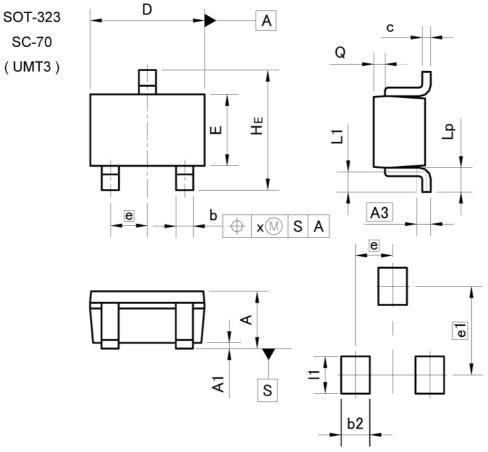
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.425		0.0	17
Lp	0.43	0.63	0.017	0.025
х	_	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	_	0.52	-	0.020
e1	1.47		0.0	58
I1	- 0.83		ı	0.033

Dimension in mm/inches





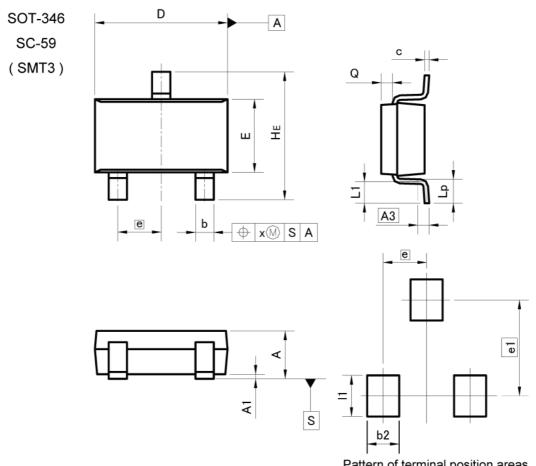
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	_	0.50	_	0.020
e1	1.55		0.061	
11	-	0.65	-	0.026

Dimension in mm/inches





Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	e=	0.004
у	- 2	0.10	( <del>-</del>	0.004

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
	b2	-	0.60	_	0.024
	e1	2.10		0.083	
	11	-3	0.90	-	0.035

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL A C C TT
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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